

NOTES:

1.MATERIAL: SHELL: SPCC

HOUSING: THERMOPLASTIC, GLASS FIBER FILLED.

UL 94V-0 RATED.

CONTACT: COPPER ALLOY

2.PLATING:

SHELL: N: NICKEL PLATED WITH Cu UNDERPLATE.

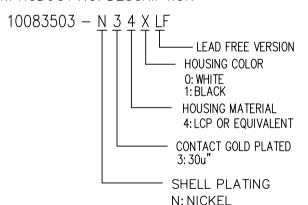
CONTACT: UNDERPLATED NICKEL OVER ALL.

MATTE TIN ON SOLDERING AREA.

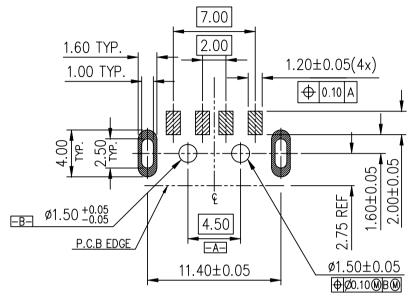
SELECTIVE GOLD PLATED ON CONTACT AREA.

3.PRODUCT SPEC NO: GS-12-265. PACKAGE SPEC NO: GS-14-874.

4.PRODUCT NO. DESCRIPTION



- 5.10083503-N34XLF: THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, IR OR VAPOR PHASE REFLOW OVEN.
- 6.THIS PRODUCT (10083503-N34XLF) MEETS THE EUROPEAN UNION DIRECTIVE AS DESCRIBED IN GS-22-008.



RECOMMENDED PCB LAYOUT

(COMPONENT SIDE) THICKNESS=1.2~1.6mm GENERAL TOLERANCE±0.05mm

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PDM: Rev:A

3 STATUS Released 22 16 66 Oct d9, 2008